L Number	Hits	Search Text	DB	Time stamp
-	53415	(chemicaladj mechanical adj polishing) or CMP	USPAT;	2004/09/22 11:29
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	771	((chemicaladj mechanical adj polishing) or CMP) and	USPAT;	2004/09/22 10:50
		((diamond adj like adj carbon) or DLC)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	2	(((chemicaladj mechanical adj polishing) or CMP) and	USPAT;	2004/09/22 10:50
		((diamond adj like adj carbon) or DLC)) and (plurality adj	US-PGPUB;	
		array)	EPO; JPO;	
			DERWENT;	
		,	IBM_TDB	
-	205	(((chemicaladj mechanical adj polishing) or CMP) and	USPAT;	2004/09/22 10:50
		((diamond adj like adj carbon) or DLC)) and array	US-PGPUB;	
			EPO; JPO;	
			DERWENT:	
			IBM_TDB	
-	213	((chemicaladj mechanical adj polishing) or CMP) and	USPAT;	2004/09/22 11:31
		(((diamond adj like adj carbon) or DLC) with (upper surface))	US-PGPUB;	
			EPO; JPO;	
			DERWENT.	
			IBM_TDB	
-	57	(((chemicaladj mechanical adj polishing) or CMP) and	USPAT;	2004/09/22 10:52
		(((diamond adj like adj carbon) or DLC) with (upper surface)))	US-PGPUB;	
		and ((((chemicaladj mechanical adj polishing) or CMP) and	EPO; JPO;	
		((diamond adj like adj carbon) or DLC)) and array)	DERWENT:	
		((,	IBM_TDB	
-	524541	(chemicaladj mechanical adj polishing) or CMP or etch\$4	USPAT;	2004/09/22 11:30
		, , , , , , , , , , , , , , , , , , , ,	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
		,	IBM_TDB	
-	771	((chemicaladj mechanical adj polishing) or CMP or etch\$4)	USPAT;	2004/09/22 11:30
		and (((chemicaladj mechanical adj polishing) or CMP) and	US-PGPUB;	
		((diamond adj like adj carbon) or DLC))	EPO; JPO;	
		, , , , , , , , , , , , , , , , , , , ,	DERWENT;	
			IBM TDB	
-	213	(((chemicaladj mechanical adj polishing) or CMP or etch\$4)	USPAT;	2004/09/22 15:06
		and (((chemicaladj mechanical adj polishing) or CMP) and	US-PGPUB;	
		((diamond adj like adj carbon) or DLC))) and (((diamond adj	EPO; JPO;	
		like adj carbon) or DLC) with (upper surface))	DERWENT;	
			IBM_TDB	
-	255	438/105,7,8,16.ccls. and ((chemicaladj mechanical adj	USPAT;	2004/09/22 15:18
		polishing) or CMP)	US-PGPUB;	
		· · · · · ·	EPO; JPO;	
			DERWENT;	
			IBM TDB	
-	5	438/105,7,8,16.ccls. and ((chemicaladj mechanical adj	USPAT;	2004/09/22 15:46
		polishing) or CMP) and ((diamond adj like adj carbon) or	US-PGPUB;	
		DLC)	EPO; JPO;	
			DERWENT:	
			IBM TDB	
-	23	438/105,7,8,16.ccls. and ((diamond adj like adj carbon) or	USPAT;	2004/09/22 15:31
		DLC)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
		<u> </u>		

-	5	438/105,7,8,16.ccls. and ((chemical adj mechanical adj	USPAT;	2004/09/22 15:47
		polishing) or CMP) and ((diamond adj like adj carbon) or	US-PGPUB;	
		DLC)	EPO; JPO;	
			DERWENT;	
			IBM TDB	